

The Electronics Division Hoffman Scholarship Application Form 2021 Essay Topic: "Artificial intelligence and data mining in electroceramics"

Application Deadline Extended: June 15th

Full Name				
Email Address				
Mailing Address				
Name of Undergraduate Department				
University				
	Total GPA	Science GPA	Total Credits	
PSAT/SAT/ACT Scores			Date of Exam	
Extracurricular Activities				
(attach additional sheets if necessary)				
Faculty Advisor*				
Address				
Telephone	()	E-mail		
Applicant's Signature			Date	
Advisor's Signature			Date	
* Essay and Recommend Matjaz Spreitzer Jozef Stefan Institute matjaz.spreitzer@ijs.si	ation letter must be e	mailed directly to:		

Nominations should also be sent to Erica Zimmerman at ezimmerman@ceramics.org.